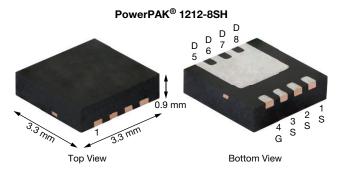
SiSH108DN

www.vishay.com

Vishay Siliconix

COMPLIANT

N-Channel 20 V (D-S) Fast Switching MOSFET



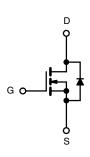
PRODUCT SUMMARY	
V _{DS} (V)	20
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0049
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0061
Q _g typ. (nC)	20
I _D (A)	22
Configuration	Single

FEATURES

- TrenchFET[®] Gen II power MOSFET for ultra low on-resistance **RoHS**
- 100 % R_q tested
- HALOGEN Material categorization: for definitions of **FREE** compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- · Point-of-load converters
- Protection devices
- Hot swap



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSH108DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, un	less otherwise	noted)		
PARAMETER		SYMBOL	10 s	STEADY STATE	UNIT
Drain-source voltage		V _{DS}	20	20	V
Gate-source voltage		V _{GS}	± 16	± 16	V
Continuous drain current (T _J = 150 °C) ^a	T _A = 25 °C	1	22	14	
	T _A = 70 °C	I _D	17.6	11.2	
Pulsed drain current		I _{DM}	60	60	A
Continuous source current (diode conduction) ^a		I _S	3.2	1.3	
Single avalanche current	L = 0.1 mH	I _{AS}	22	22	
Single avalanche energy		E _{AS}	24	24	mJ
	T _A = 25 °C	D	3.8	1.5	W
Maximum power dissipation ^a	T _A = 70 °C	P _D	2.0	0.8	vv
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		°C
Soldering recommendations (peak temperature) b, c			2	60	C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^a	t ≤ 10 s	Р	24	33	
	Steady state	R _{thJA}	65	81	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.9	2.4	

Notes

a. Surface mounted on 1" x 1" FR4 board

b. See solder profile (www.vishav.com/doc?73257). The PowerPAK 1212-8SH is a leadless package within the PowerPAK 1212-8 package family. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

S18-0685-Rev. A, 09-Jul-2018

SiSH108DN

SPECIFICATIONS ($T_J = 25$ °C	C, unless otl	herwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•	•			
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	2	V	
Gate body leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm \text{ 16 V}$	-	-	± 100	nA	
Zara gata voltaga drain ourrant		$V_{DS} = 20 V, V_{GS} = 0 V$	-	-	1		
Zero gate voltage drain current	IDSS	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	5	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	40	-	-	А	
Drain-source on-state resistance ^a	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 22 \text{ A}$	-	0.0041	0.0049	Ω	
Drain-source on-state resistance "	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 19.7 \text{ A}$	-	0.0050	0.0061		
Forward transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 22 \text{ A}$	-	88	-	S	
Diode forward voltage ^a	V _{SD}	$I_{S} = 3.2 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.75	1.2	V	
Dynamic ^b							
Total gate charge	Qg		-	20	30		
Gate-source charge	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 22 A	-	6.3	-	nC	
Gate-drain charge	Q _{gd}		-	4.9	-		
Gate resistance	Rg	f = 1 MHz	0.7	1.4	2.1	Ω	
Turn-on delay time	t _{d(on)}		-	10	15		
Rise time	t _r	V_{DD} = 20 V, R_L = 20 Ω	-	10	15		
Turn-off delay time	t _{d(off)}	$I_D \cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω	-	60	130	ns	
Fall time	t _f		-	10	15		
Source-drain reverse recovery time	t _{rr}		-	30	60		
Reverse recovery charge	Q _{rr}	I _F = 3.2 A, di/dt = 100 A/μs	-	20	36	nC	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

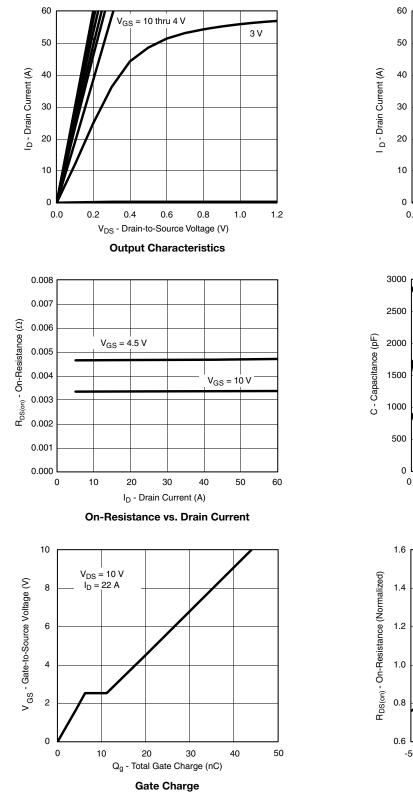
b. Guaranteed by design, not subject to production testing

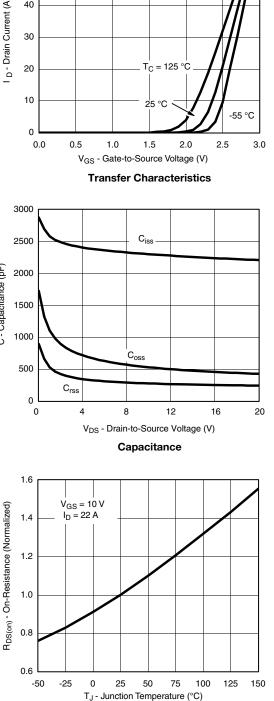
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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





On-Resistance vs. Junction Temperature

S18-0685-Rev. A, 09-Jul-2018

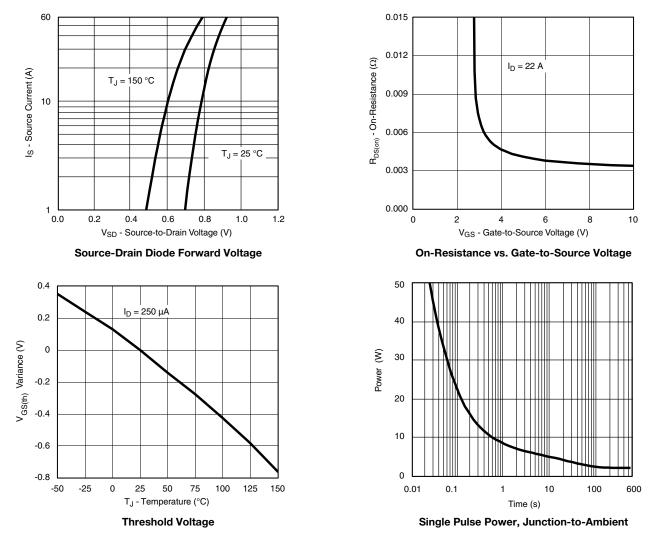
3

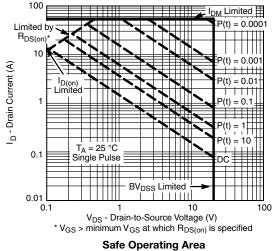
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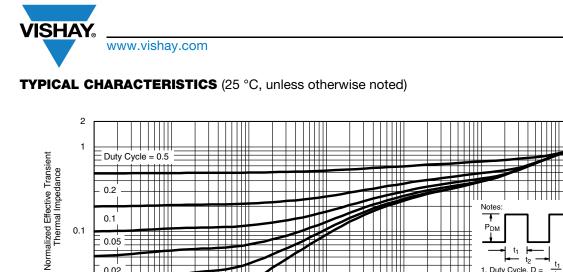
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+++

10-2

Vishay Siliconix

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Ambient

1

10-1

P_{DM}

10

t₁

1. Duty Cycle, D =

4. Surface Mounted

t2

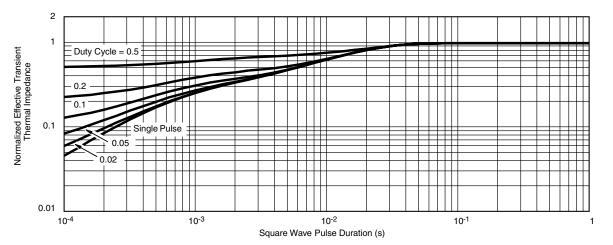
3. T_{JM} - $T_A = P_{DM}Z_{thJA}^{(t)}$

t₁ t₂

100

600

2. Per Unit Base = R_{thJA} = 65 °C/W



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?79330.

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0.1

0.01 10-4

0.05

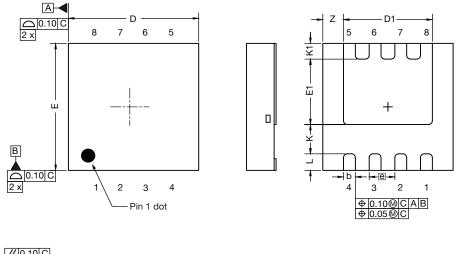
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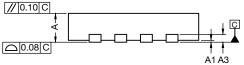
10⁻³

Single Pulse



Case Outline for PowerPAK[®] 1212-SWLH and PowerPAK[®] 1212-8SH



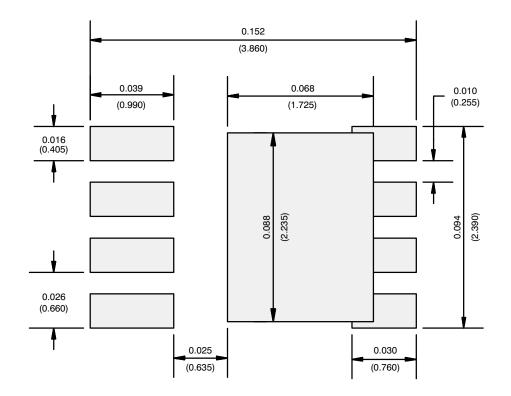


DIM		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.82	0.90	0.98	0.032	0.035	0.038		
A1	0.00	-	0.05	0.000	-	0.002		
A3		0.20 ref.			0.008 ref.			
b	0.25	0.30	0.35	0.010	0.012	0.014		
D	3.20	3.30	3.40	0.126	0.130	0.134		
D1	2.15	2.25	2.35	0.085	0.089	0.093		
E	3.20	3.30	3.40	0.126	0.130	0.134		
E1	1.60	1.70	1.80	0.063	0.067	0.071		
е		0.65 bsc. 0.026 bsc.						
К		0.76 ref.			0.030 ref.			
K1		0.41 ref.			0.016 ref.			
L	0.33	0.43	0.53	0.013	0.017	0.021		
Z	0.525 ref.				0.021 ref.	•		

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RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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